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Product Change Notification

Change Notification #:	**118373-00**
Change Title:	**Select Intel® SSD D7-P5510 Series PCN 118373-00, Product Material, Adding Second Source Diodes**
Date of Publication:	**July 14, 2021**

Key Characteristics of the Change:
Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	August 13, 2021

Description of Change to the Customer:
The Intel SKUs listed in the products affected table will have the following changes.

- Current Schottky Diode IPN# J32701-001 EOL-ing (supplier ROHM) and adding new IPN# J32701-003 (supplier Diodes Inc.) as alternate part.

Customer Impact of Change and Recommended Action:
This change has been thoroughly evaluated to ensure that there are no quality, reliability, or functional implications to our customers. Intel is not recommending additional qualification of these changes on platforms received from Intel. There is no change to form fit or function.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#
Intel® SSD D7-P5510 Series (3.84TB, 2.5in PCIe 4.0 x4, 3D4, TLC) Generic Single Pack OPAL	SSDPF2KX038TZOS	99A5CZ
Intel® SSD D7-P5510 Series (7.68TB, 2.5in PCIe 4.0 x4, 3D4, TLC) Generic Single Pack OPAL	SSDPF2KX076TZOS	99A5D1
Intel® SSD D7-P5510 Series (3.84TB, 2.5in PCIe 4.0 x4, 3D4, TLC) Generic 50 Pack	SSDPF2KX038TZ	99AJR9
Intel® SSD D7-P5510 Series (7.68TB, 2.5in PCIe 4.0 x4, 3D4, TLC) Generic 50 Pack	SSDPF2KX076TZ	99AJRA
Intel® SSD D7-P5510 Series (3.84TB, 2.5in PCIe 4.0 x4, 3D4, TLC) Generic Single Pack	SSDPF2KX038TZ01	99A5DP
Intel® SSD D7-P5510 Series (7.68TB, 2.5in PCIe 4.0 x4, 3D4, TLC) Generic Single Pack	SSDPF2KX076TZ01	99A5DR

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
July 14, 2021	00	Originally Published PCN

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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